Copper foil adhesive tape

## DAITAC ${ }^{\circledR}$ E-0100LC

## Construction



## Characteristics

$\checkmark$ Tape thickness is $20 \mu \mathrm{~m}$.
$\checkmark$ Excellent adhesion
$\checkmark$ Good heat dissipation due to copper foil carrier
$\checkmark$ Product does not use the 6 restrictive substances of the RoHS Directive.

## Applications

$\checkmark$ For EMI shielding of electronic equipment.
$\checkmark$ For heat dissipation of electronic equipment

## Properties

| Test item | Condition | Substrate | Unit | E-0100LC |
| :---: | :---: | :---: | :---: | :---: |
| Thickness | Except release liner | - | $\mu \mathrm{m}$ | 20 |
| 180 deg. peel strength | $23^{\circ} \mathrm{C}, 1 \mathrm{hr}$ | SUS (hairline) | $\mathrm{N} / 25 \mathrm{~mm}$ | 16 |
| Static shear | $100^{\circ} \mathrm{C}, 0.1 \mathrm{~kg}$ | SUS (hairline) | hr | $24<$ |

Size $\quad 1,000 \mathrm{~mm}$ in max width $\quad 50 \mathrm{~m}$ in length

